PCN Number:	2015090300	20150903000			PCN Date:		09/08/2015	
Title: Datasheet for UCD3138A								
<b>Customer Contact:</b>	PCN Manager				ept: Quality Services			
Change Type:					-			
Assembly Site		Design			Wafer	- Bum	p Site	
Assembly Process		🛛 Data Sh	eet				r Bump Material	
Assembly Materials		Part nui	mber change				p Process	
Mechanical Specification		Test Sit			Wafer			
Packing/Shipping/Labeling		Test Pro	cess			er Fab Materials		
	ion Dotoila		Wafer	- Fab	Process			
Notification Details								
<b>Description of Change:</b> Texas Instruments Incorporated is announcing an information only notification etc.								
The product datasheet(s) is being updated as summarized below. The following change history provides further details.								
TEXAS INSTRUMENTS UCD3138A SLUSC66B - MARCH 2015 - REVISED MAY 2015								
Changes from Revision A (April 2015) to Revision B Page								
Changed Figure 6-3 image and following notes								
The datasheet number will be changing.								
Device Family	Change From:			Change To:				
UCD3138A			SLUSC66A			SLUSC66B		
These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/UCD3138A								
Reason for Change:								
To more accurately reflect device characteristics.								
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):								
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.								
Changes to product identification resulting from this PCN:								
None.								
Product Affected:								
UCD3138ARGCR	UCD3138A	RGCT	UCD3138ARM	IR	U	CD31	38ARMHT	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com